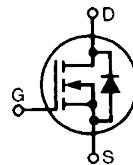


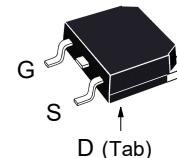
**TrenchT2™ HiPerFET™
Power MOSFET**
**IXFH340N075T2
IXFT340N075T2**

V_{DSS} = 75V
I_{D25} = 340A
R_{DS(on)} ≤ 3.2mΩ

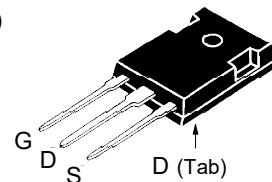
N-Channel Enhancement Mode
 Avalanche Rated
 Fast Intrinsic Diode



**TO-268
(IXFT)**



**TO-247
(IXFH)**



G = Gate D = Drain
 S = Source Tab = Drain

Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	T _J = 25°C to 175°C	75	75	V
V _{DGR}	T _J = 25°C to 175°C, R _{GS} = 1MΩ	75	75	V
V _{GSM}	Transient	± 20	± 20	V
I _{D25}	T _c = 25°C (Chip Capability)	340	340	A
I _{LRMS}	Lead Current Limit, RMS	160	160	A
I _{DM}	T _c = 25°C, Pulse Width Limited by T _{JM}	850	850	A
I _A	T _c = 25°C	170	170	A
E _{AS}	T _c = 25°C	960	960	mJ
P _D	T _c = 25°C	935	935	W
T _J		-55 ... +175	-55 ... +175	°C
T _{JM}		175	175	°C
T _{stg}		-55 ... +175	-55 ... +175	°C
T _L	Maximum Lead Temperature for Soldering	300	300	°C
T _{SOLD}	Plastic Body for 10 seconds	260	260	°C
M _d	Mounting Torque (TO-247)	1.13/10	1.13/10	Nm/lb.in.
Weight	TO-247	6	6	g
	TO-268	4	4	g

Symbol	Test Conditions (T _J = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV _{DSS}	V _{GS} = 0V, I _D = 1mA	75		V
V _{GS(th)}	V _{DS} = V _{GS} , I _D = 3mA	2.0		4.0 V
I _{GSS}	V _{GS} = ± 20V, V _{DS} = 0V			±200 nA
I _{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V T _J = 150°C			25 μA
R _{DS(on)}	V _{GS} = 10V, I _D = 100A, Note 1			1.5 mA
				3.2 mΩ

Features

- International Standard Packages
- 175°C Operating Temperature
- High Current Handling Capability
- Avalanche Rated
- Fast Intrinsic Diode
- Low R_{DS(on)}

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC/DC Converters and Off-line UPS
- Primary- Side Switch
- High Current Switching Applications



IXFH340N075T2
IXFT340N075T2

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	$V_{DS} = 10\text{V}$, $I_D = 60\text{A}$, Note 1	65	110	S
C_{iss} C_{oss} C_{rss}	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$	19	nF	
		2230	pF	
		490	pF	
R_{Gi}	Gate Input Resistance	1.7	Ω	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 100\text{A}$ $R_G = 1\Omega$ (External)	26	ns	
		50	ns	
		60	ns	
		35	ns	
$Q_{g(on)}$ Q_{gs} Q_{gd}	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$	300	nC	
		68	nC	
		70	nC	
R_{thJC}			0.16 $^\circ\text{C}/\text{W}$	
R_{thCH}	TO-247	0.21	$^\circ\text{C}/\text{W}$	

Source-Drain Diode

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I_s	$V_{GS} = 0\text{V}$		340	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}		1360	A
V_{SD}	$I_F = 100\text{A}$, $V_{GS} = 0\text{V}$, Note 1		1.3	V
t_{rr} I_{RM} Q_{RM}	$I_F = 170\text{A}$, $V_{GS} = 0\text{V}$ $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 37.5\text{V}$	75	ns	
		4.4	A	
		165	nC	

Note 1. Pulse test, $t \leq 300\mu\text{s}$; duty cycle, $d \leq 2\%$.

Littelfuse reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2
4,860,072 5,017,508 5,063,307 5,381,025 6,259,123B1 6,534,343 6,710,405B2 6,759,692 7,063,975B2
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

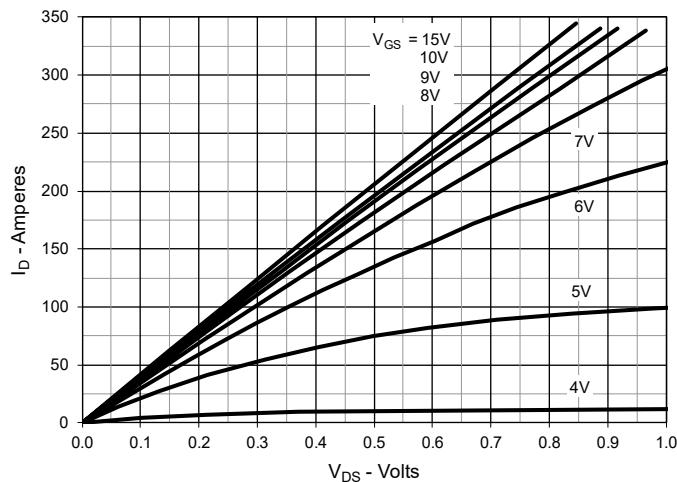
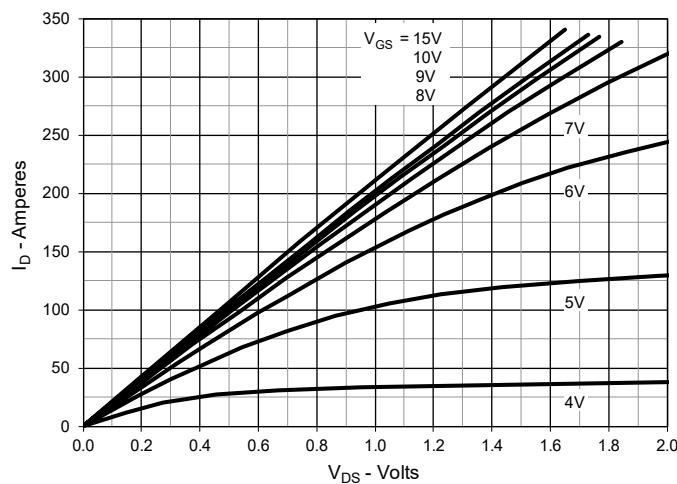
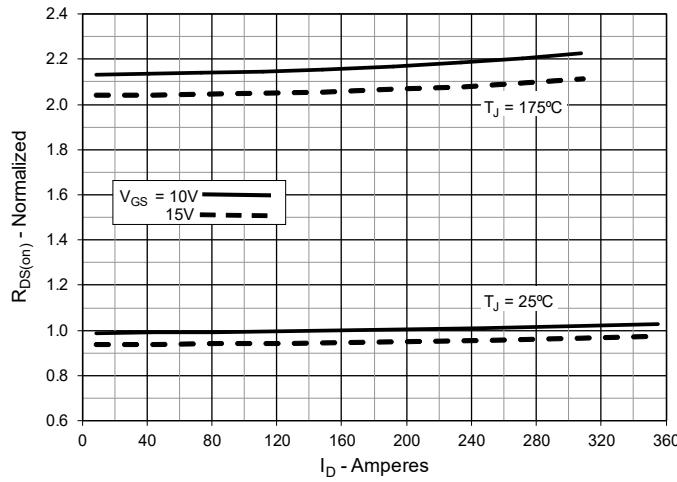
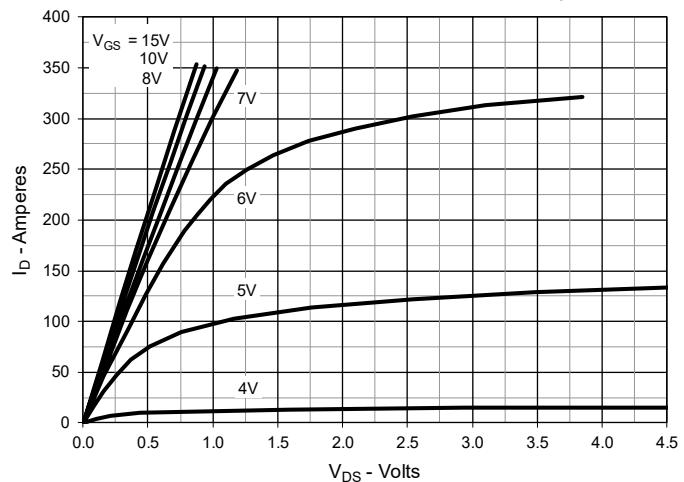
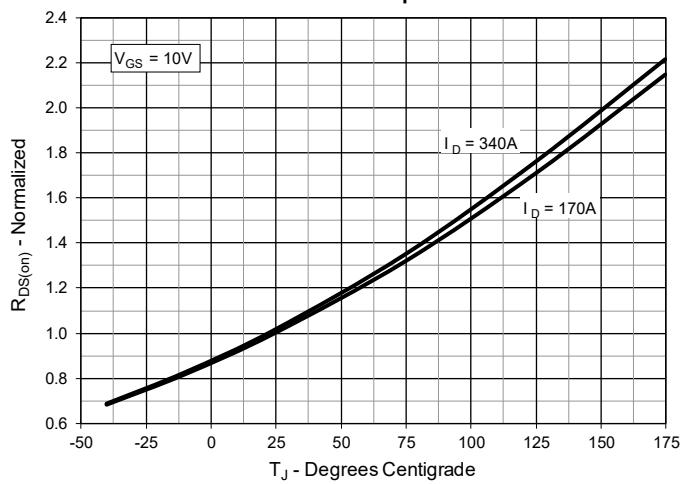
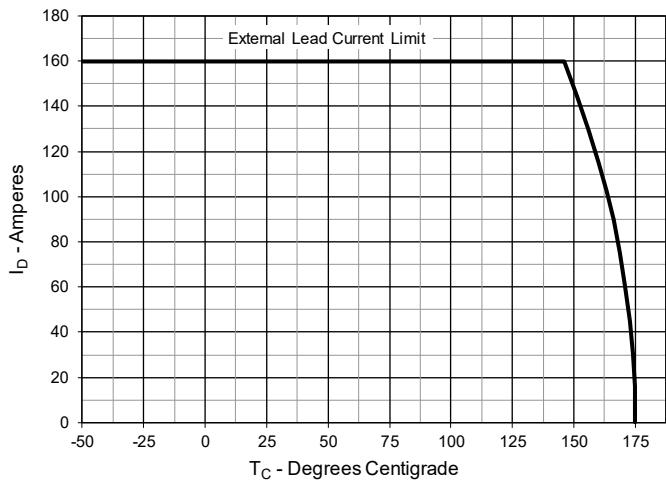
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 150^\circ\text{C}$

Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 170\text{A}$ Value vs. Drain Current

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 170\text{A}$ Value vs. Junction Temperature

Fig. 6. Drain Current vs. Case Temperature


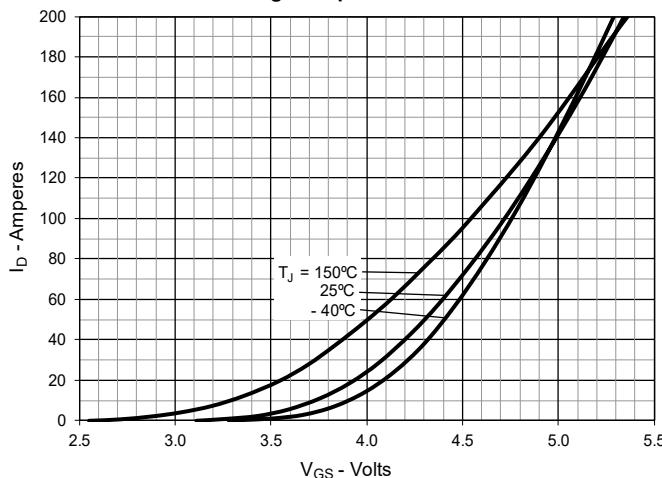
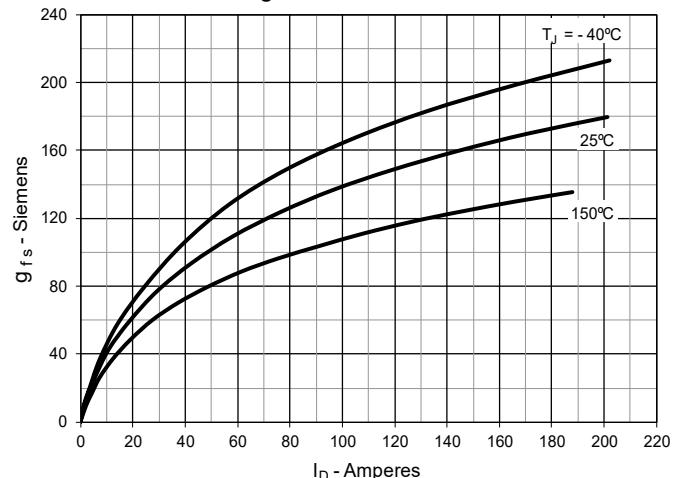
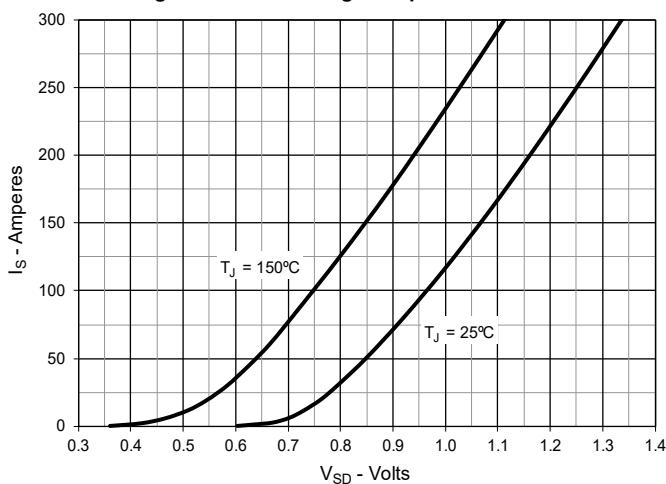
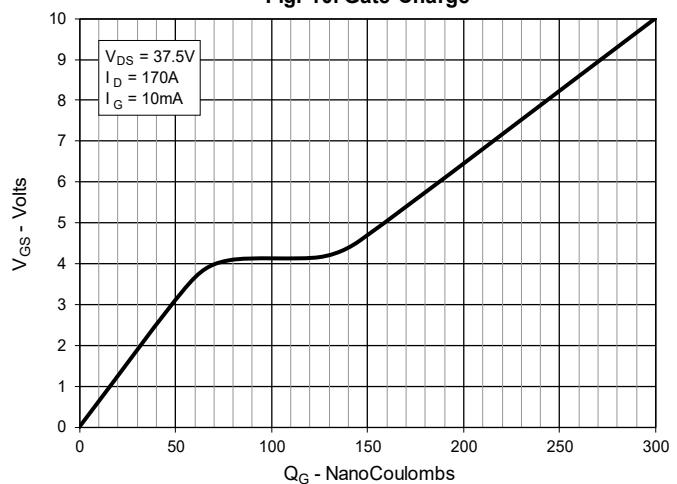
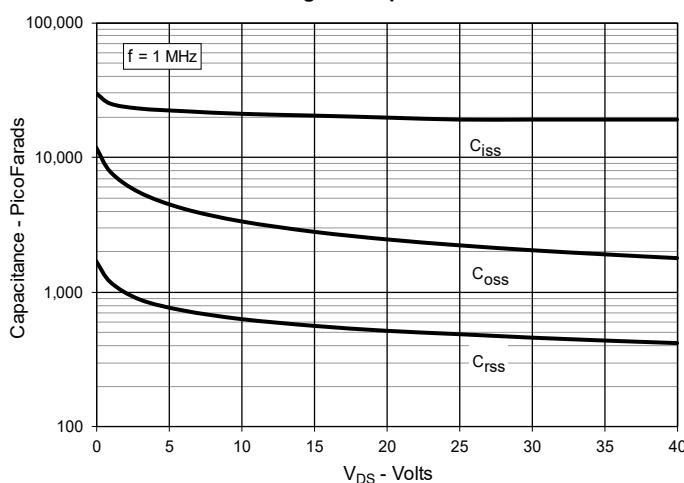
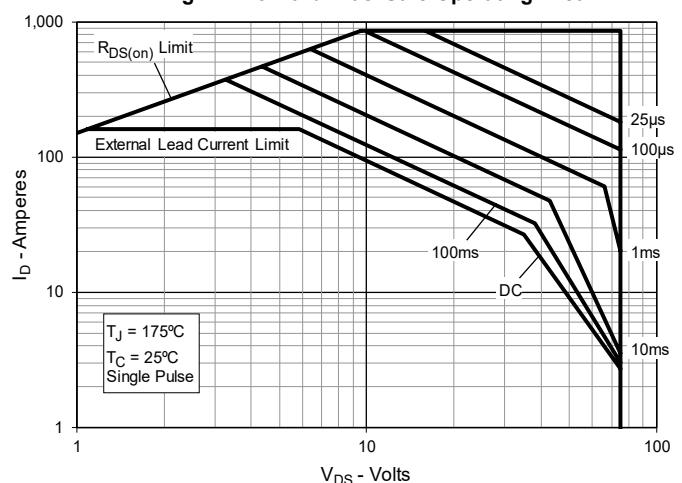
Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Forward-Bias Safe Operating Area


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

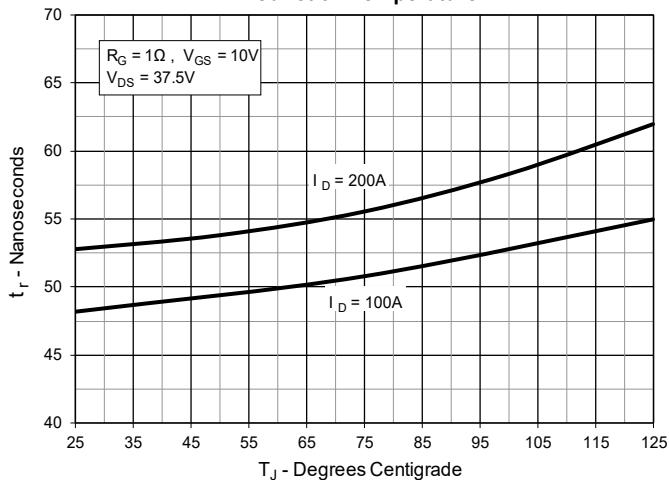


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

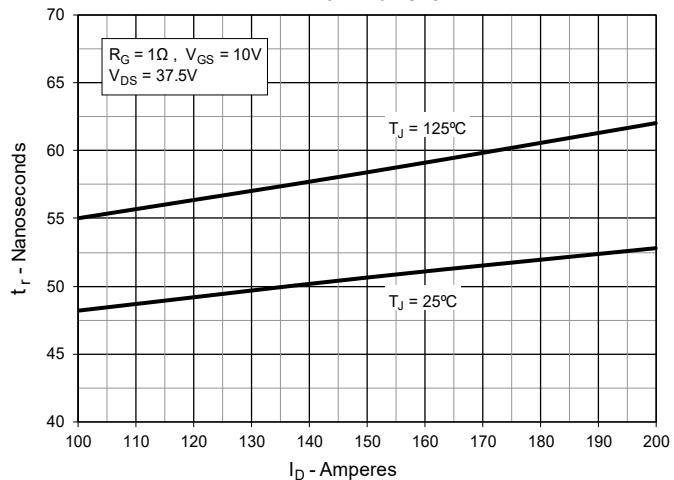


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

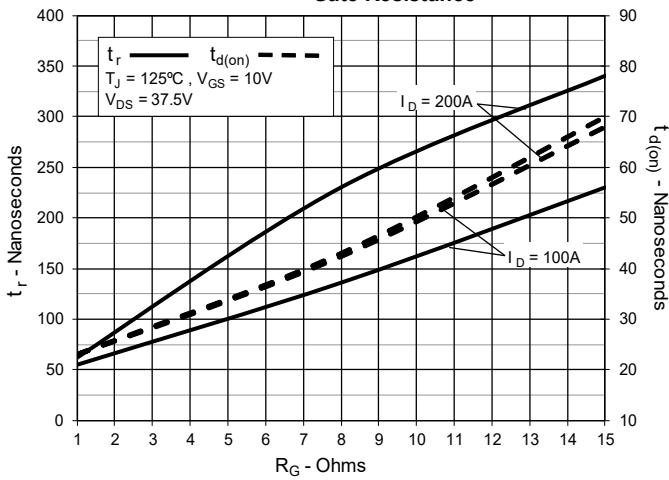


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

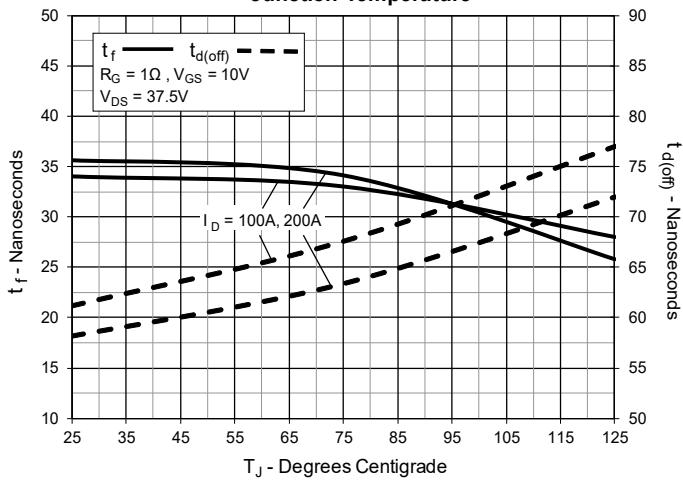


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

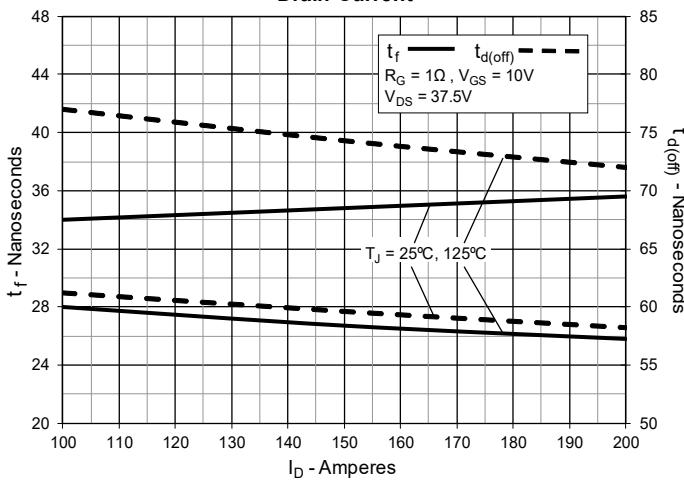


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance

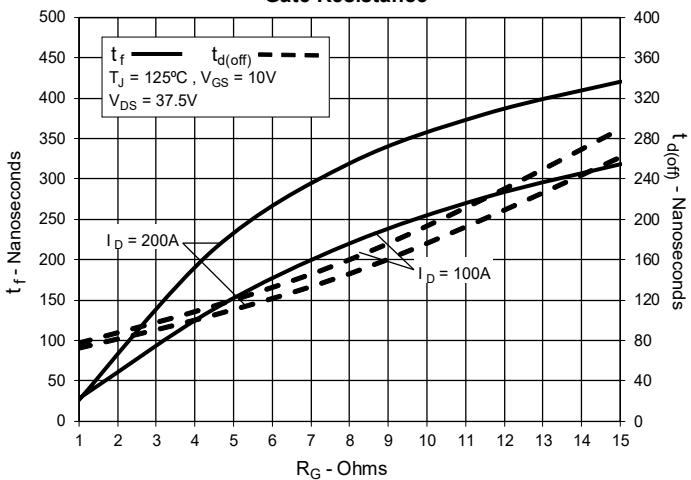
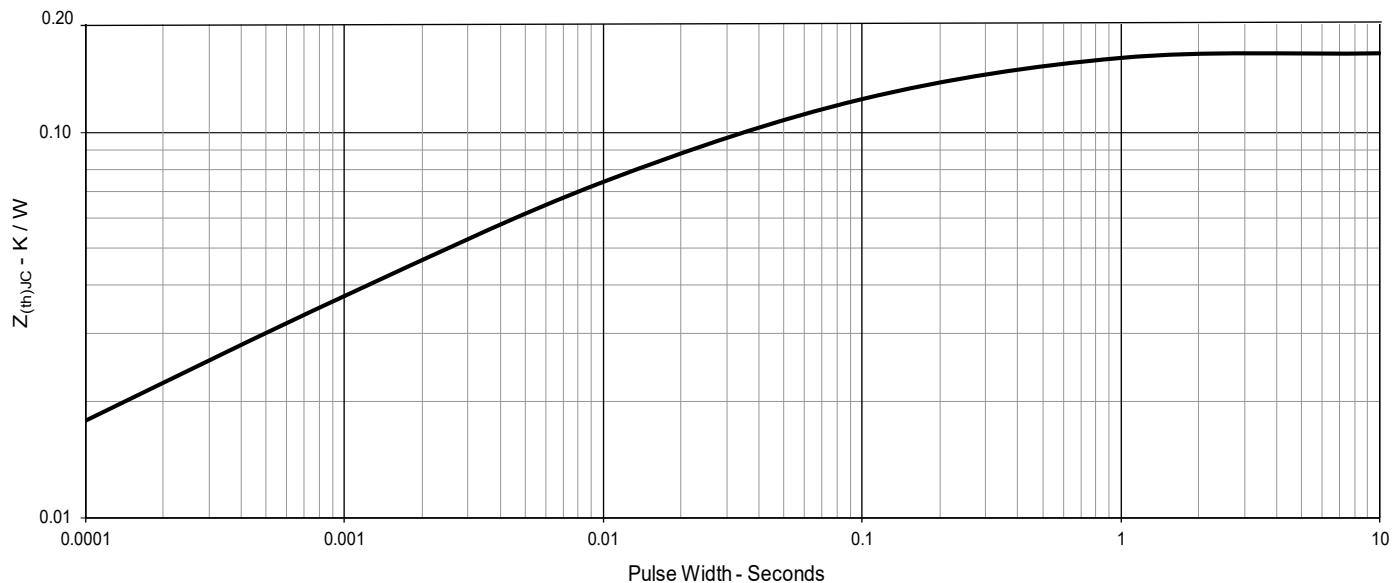
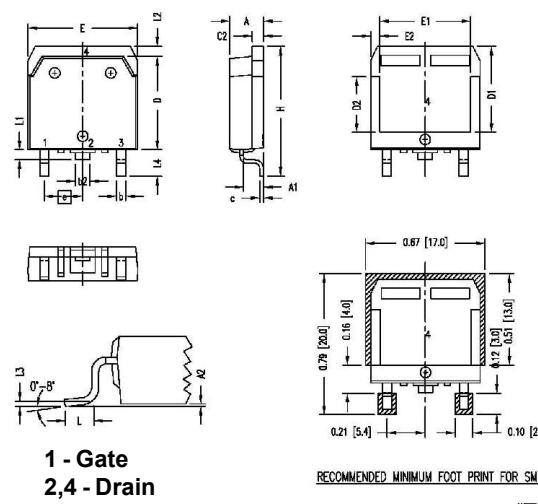
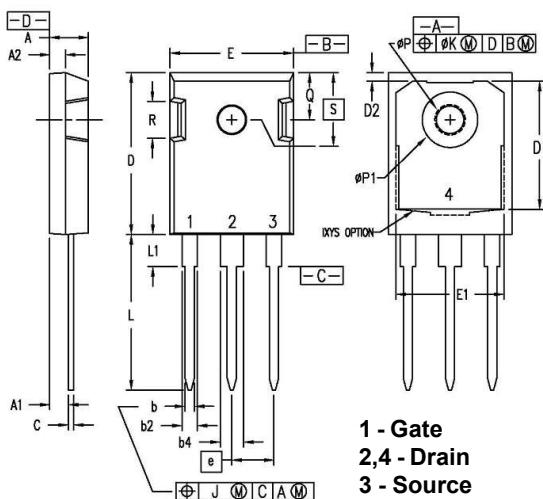


Fig. 19. Maximum Transient Thermal Impedance

TO-268 Outline


SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
D2	.320	.335	8.13	8.50
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
E2	.045	.055	1.14	1.39
e	.215	BSC	5.45	BSC
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25	BSC
L4	.150	.161	3.80	4.10

NOTE: ALL METAL SURFACE ARE MATT PURPLE TIN PLATED EXCEPT TRIM AREA
 Pb PLATING THICKNESS (4 - 20 μ m)

TO-247 Outline


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b2	.075	.087	1.91	2.20
b4	.115	.126	2.92	3.20
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
D1	.650	.690	16.51	17.53
D2	.035	.050	0.89	1.27
E	.620	.635	15.75	16.13
E1	.545	.565	13.84	14.35
e	.215	BSC	5.45	BSC
J	--	.010	--	0.25
K	--	.025	--	0.64
L	.780	.810	19.81	20.57
L1	.150	.170	3.81	4.32
ØP	.140	.144	3.55	3.65
ØP1	.275	.290	6.99	7.37
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.242	BSC	6.15	BSC

NOTE: This drawing will meet all dimensions requirement of JEDEC outlines TO-247 AD (R-PSIP-F3)